

## Automotive-grade N-channel 200 V, 0.066 Ω typ., 30 A, STripFET™ Power MOSFET in D<sup>2</sup>PAK package

Datasheet - production data

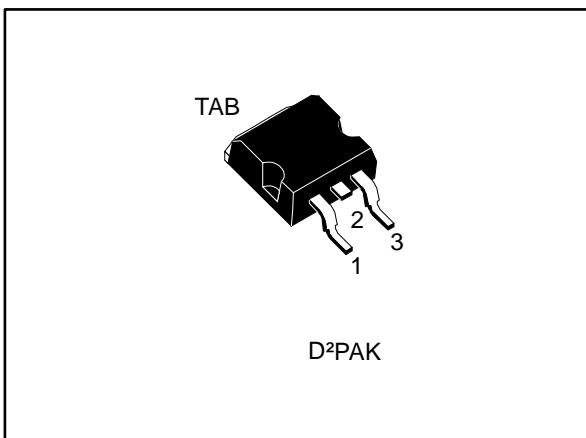
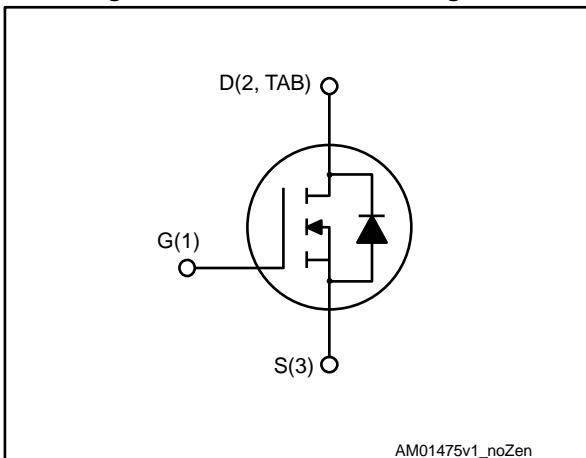


Figure 1: Internal schematic diagram



### Features

Order code	V <sub>DS</sub>	R <sub>D(on)</sub> max.	I <sub>D</sub>	P <sub>TOT</sub>
STB30NF20L	200 V	0.075 Ω	30 A	150 W

- AEC-Q101 qualified
- Gate charge minimized
- 100% avalanche tested
- Excellent FoM (figure of merit)
- Very low intrinsic capacitance



### Applications

- Switching applications

### Description

This N-channel enhancement mode Power MOSFET benefits from the latest refinement of STMicroelectronics' unique "single feature size" strip-based process, which decreases the critical alignment steps to offer exceptional manufacturing reproducibility. The result is a transistor with extremely high packing density for low on-resistance, rugged avalanche characteristics and low gate charge.

Table 1: Device summary

Order code	Marking	Package	Packaging
STB30NF20L	30NF20L	D <sup>2</sup> PAK	Tape and reel

## Contents

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# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	200	V
$V_{GS}$	Gate-source voltage	$\pm 20$	V
$I_D$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	30	A
	Drain current (continuous) at $T_C = 100^\circ\text{C}$	19	A
$I_{DM}^{(1)}$	Drain current (pulsed)	120	A
$P_{TOT}$	Total dissipation at $T_C = 25^\circ\text{C}$	150	W
$dv/dt^{(2)}$	Peak diode recovery voltage slope	10	V/ns
$T_{stg}$	Storage temperature range	- 55 to 175	$^\circ\text{C}$
$T_j$	Operating junction temperature range		

**Notes:**

(1) Pulse width is limited by safe operating area.

(2)  $I_{SD} \leq 30 \text{ A}$ ,  $di/dt \leq 200 \text{ A}/\mu\text{s}$ ,  $V_{DD} = 80\% V_{(BR)DSS}$ 

Table 3: Thermal data

Symbol	Parameter	Value	Unit
$R_{thJC}$	Thermal resistance junction-case	1	$^\circ\text{C}/\text{W}$
$R_{thJA}$	Thermal resistance junction-ambient	62.5	$^\circ\text{C}/\text{W}$

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
$I_{AR}$	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax.}$ )	30	A
$E_{AS}$	Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 50 \text{ V}$ )	140	mJ

## 2 Electrical characteristics

( $T_{CASE} = 25^\circ C$  unless otherwise specified)

**Table 5: On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	200			V
$I_{DSS}$	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 200 \text{ V}$			1	$\mu\text{A}$
		$V_{GS} = 0 \text{ V}, V_{DS} = 200 \text{ V}, T_C = 125^\circ C$ (1)			10	$\mu\text{A}$
$I_{GSS}$	Gate source leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			$\pm 100$	$\mu\text{A}$
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	1	2	3	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 5 \text{ V}, I_D = 15 \text{ A}$		0.066	0.075	$\Omega$

**Notes:**

(1)Defined by design, not subject to production test.

**Table 6: Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0 \text{ V}$	-	1990	-	pF
$C_{oss}$	Output capacitance		-	297	-	pF
$C_{rss}$	Reverse transfer capacitance		-	42	-	pF
$Q_g$	Total gate charge	$V_{DD} = 160 \text{ V}, I_D = 30 \text{ A}, V_{GS} = 0 \text{ to } 10 \text{ V}$ (see <a href="#">Figure 14: "Test circuit for gate charge behavior"</a> )	-	65	-	nC
$Q_{gs}$	Gate-source charge		-	7	-	nC
$Q_{gd}$	Gate-drain charge		-	21	-	nC

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 100 \text{ V}, I_D = 15 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see <i>Figure 13: "Test circuit for resistive load switching times"</i> and <i>Figure 18: "Switching time waveform"</i> )	-	14	-	ns
$t_r$	Rise time		-	12	-	ns
$t_{d(off)}$	Turn-off delay time		-	68	-	ns
$t_f$	Fall time		-	14	-	ns

Table 8: Source-drain diode

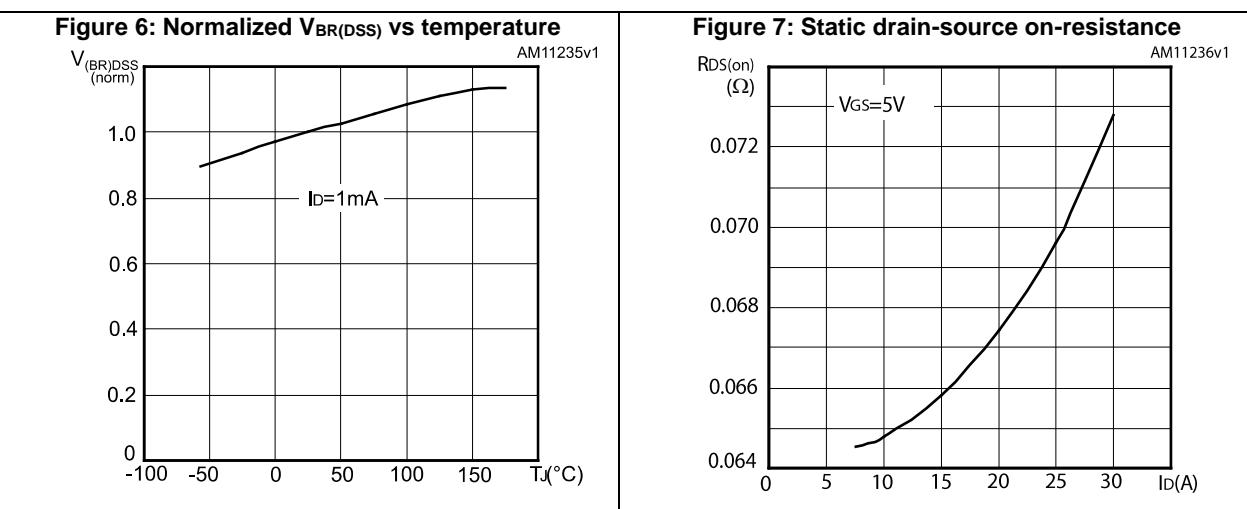
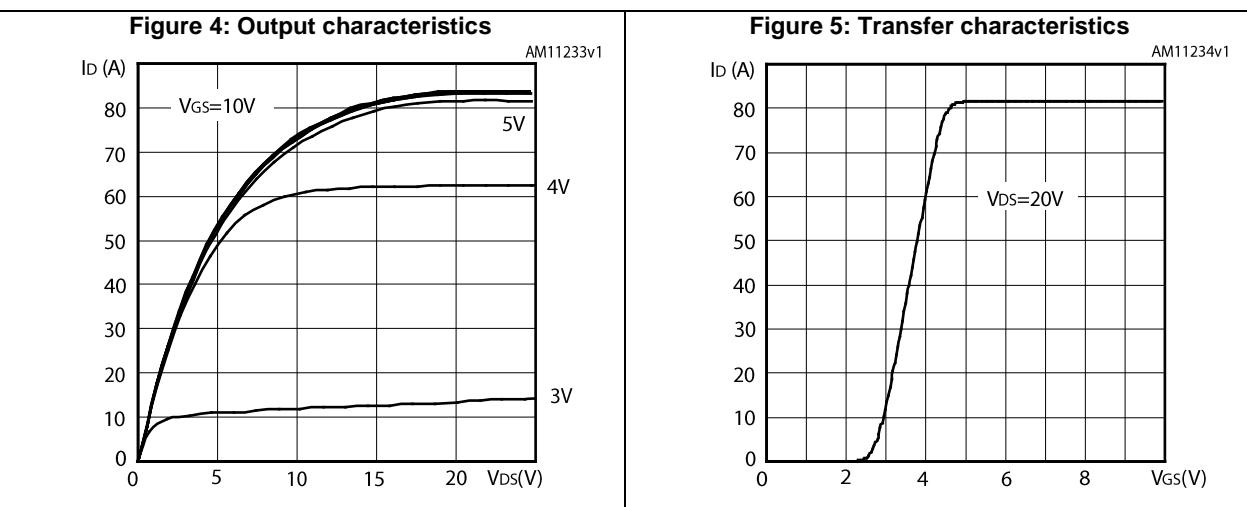
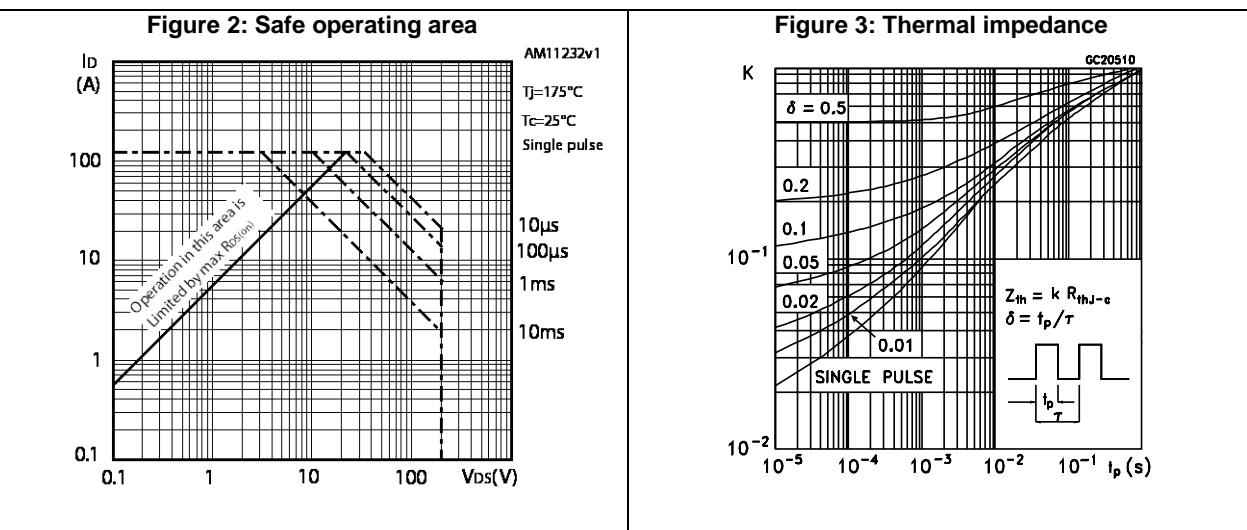
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current	$V_{SD} = 1.5 \text{ V}$	-		30	A
$I_{SDM^{(1)}}$	Source-drain current (pulsed)		-		120	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 30 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.5	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 30 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$	-	140		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 100 \text{ V}$ (see <i>Figure 15: "Test circuit for inductive load switching and diode recovery times"</i> )	-	0.75		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current	$I_{SD} = 30 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 100 \text{ V}, T_j = 150^\circ\text{C}$ (see <i>Figure 15: "Test circuit for inductive load switching and diode recovery times"</i> )	-	13		A
$t_{rr}$	Reverse recovery time		-	170		ns
$Q_{rr}$	Reverse recovery charge		-	1.1		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current		-	14		A

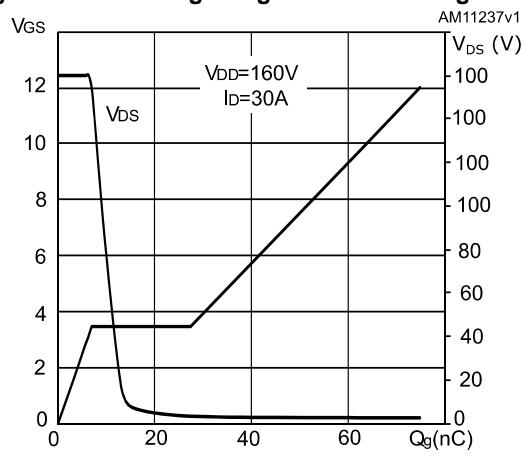
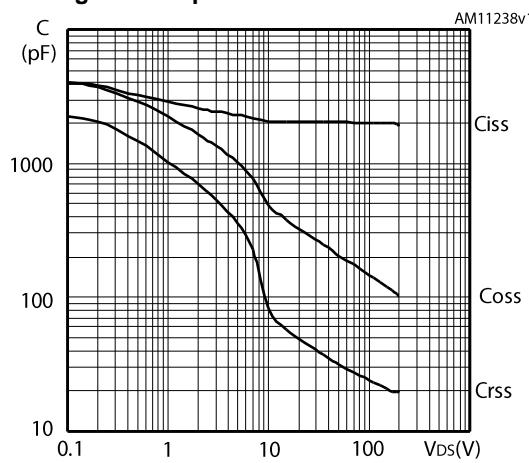
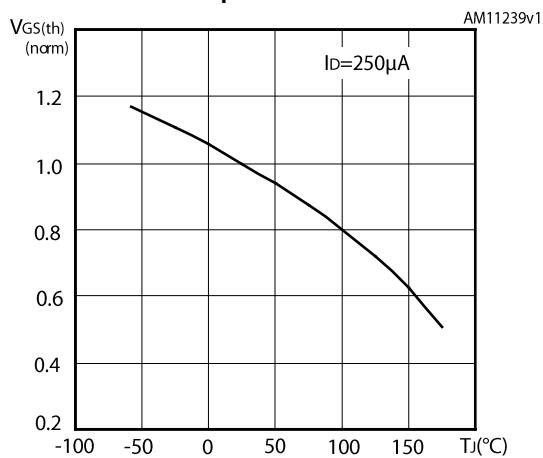
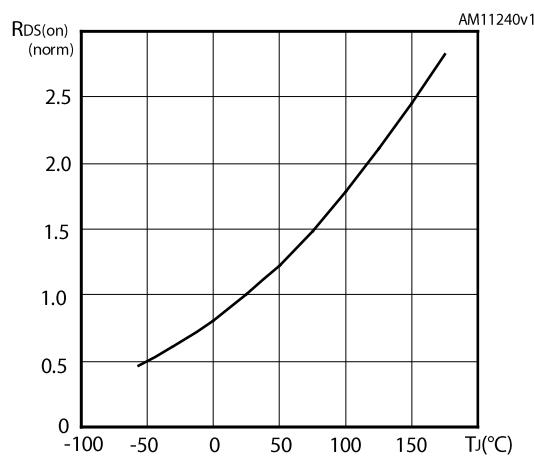
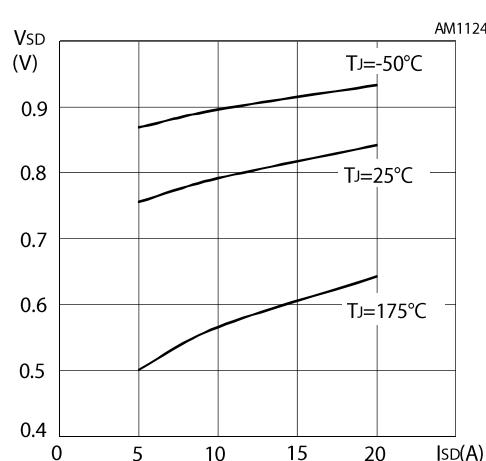
**Notes:**

(1)Pulse width is limited by safe operating area.

(2)Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

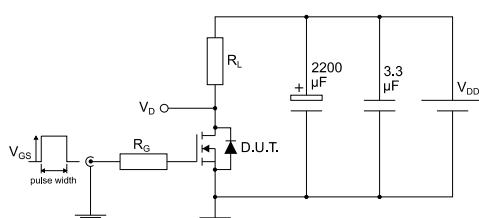
## 2.1 Electrical characteristics (curves)



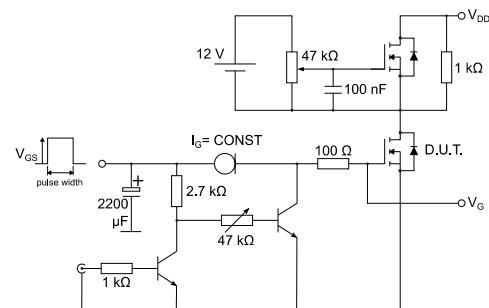
**STB30NF20L****Electrical characteristics****Figure 8: Gate charge vs gate-source voltage****Figure 9: Capacitance variations****Figure 10: Normalized gate threshold voltage vs temperature****Figure 11: Normalized on-resistance vs temperature****Figure 12: Source-drain diode forward characteristics**

### 3 Test circuits

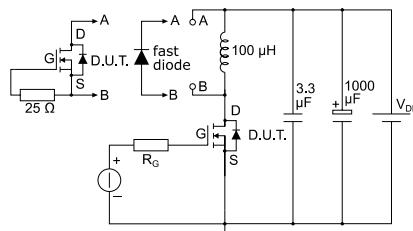
**Figure 13: Test circuit for resistive load switching times**



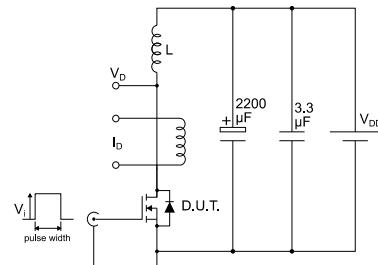
**Figure 14: Test circuit for gate charge behavior**



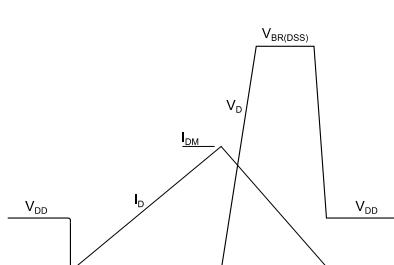
**Figure 15: Test circuit for inductive load switching and diode recovery times**



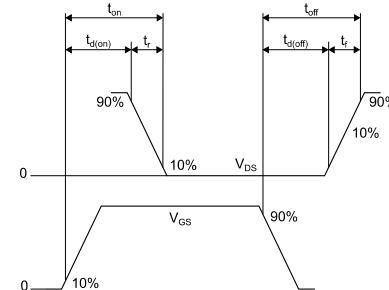
**Figure 16: Unclamped inductive load test circuit**



**Figure 17: Unclamped inductive waveform**



**Figure 18: Switching time waveform**



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

### 4.1 D<sup>2</sup>PAK package information

Figure 19: D<sup>2</sup>PAK (TO-263) type A package outline

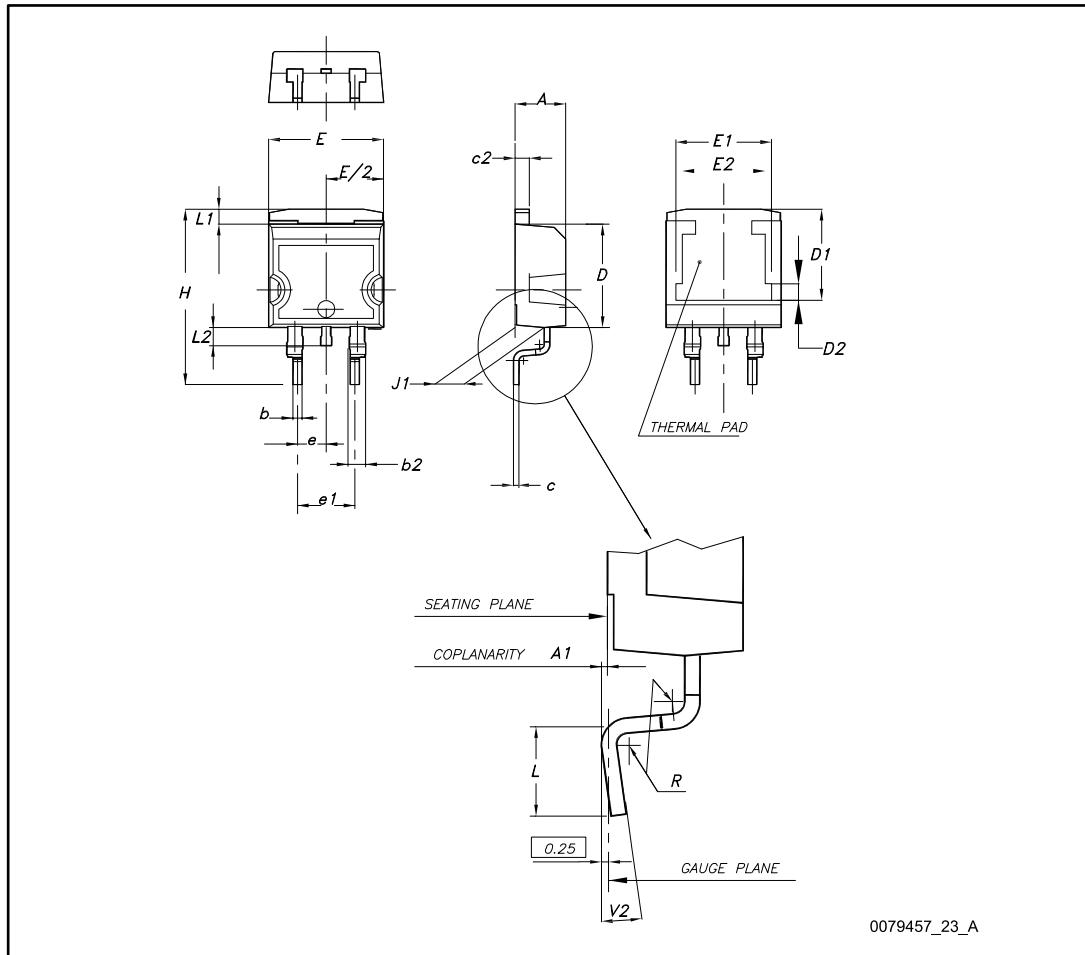
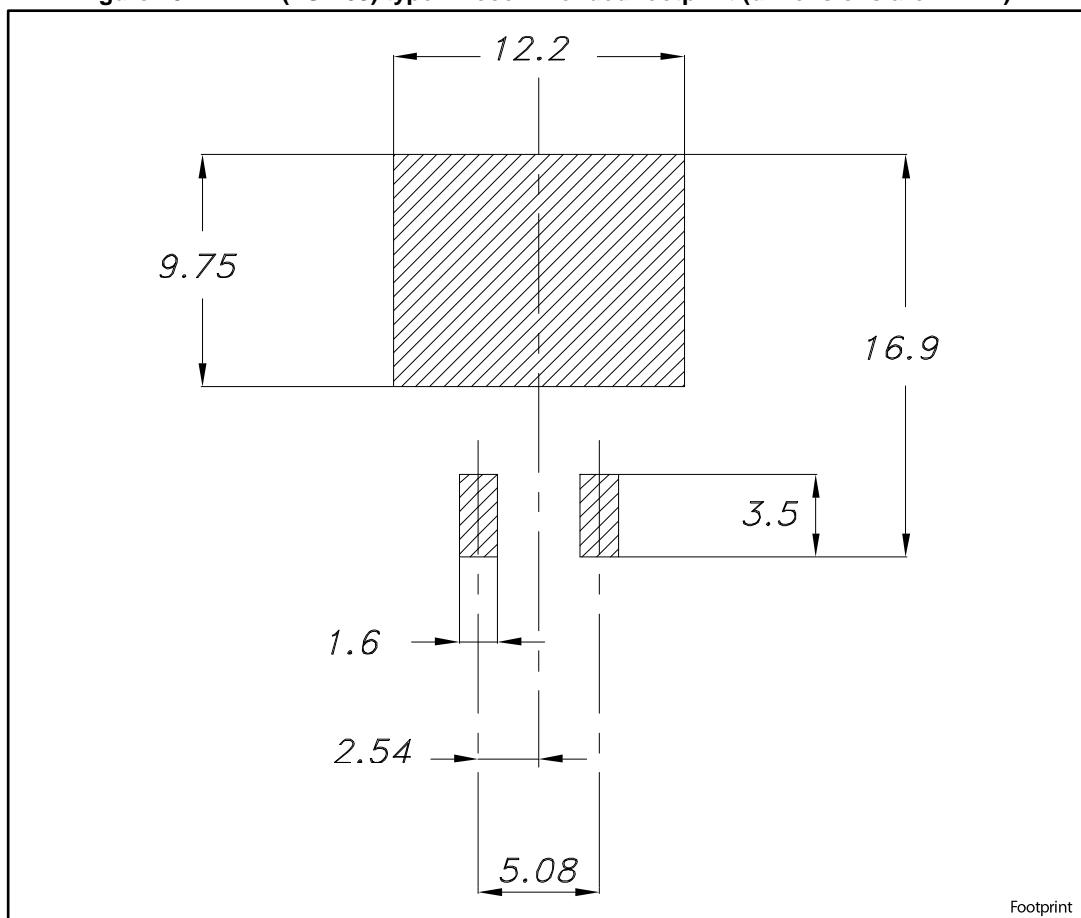


Table 9: D<sup>2</sup>PAK (TO-263) type A package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
c	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50	7.75	8.00
D2	1.10	1.30	1.50
E	10.00		10.40
E1	8.50	8.70	8.90
E2	6.85	7.05	7.25
e		2.54	
e1	4.88		5.28
H	15.00		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.40	
V2	0°		8°

Figure 20: D<sup>2</sup>PAK (TO-263) type A recommended footprint (dimensions are in mm)

## 4.2 D<sup>2</sup>PAK packing information

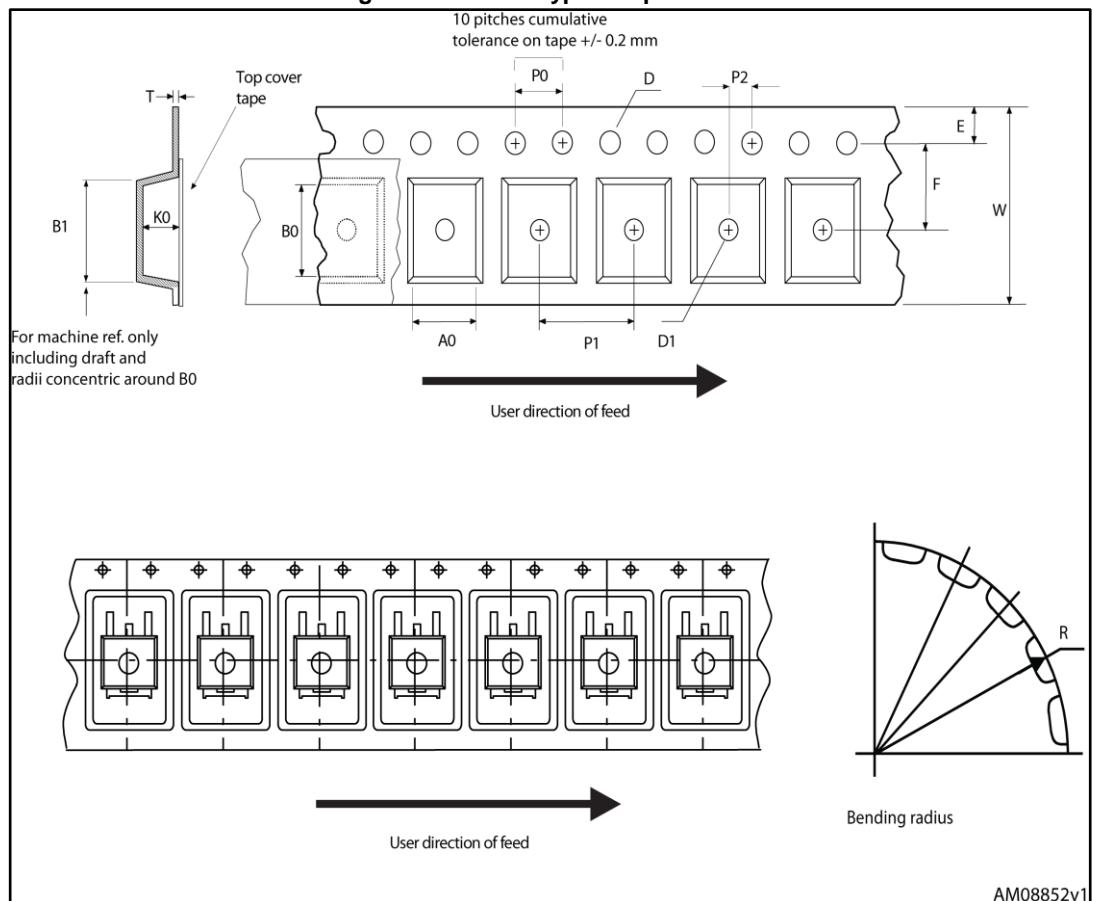
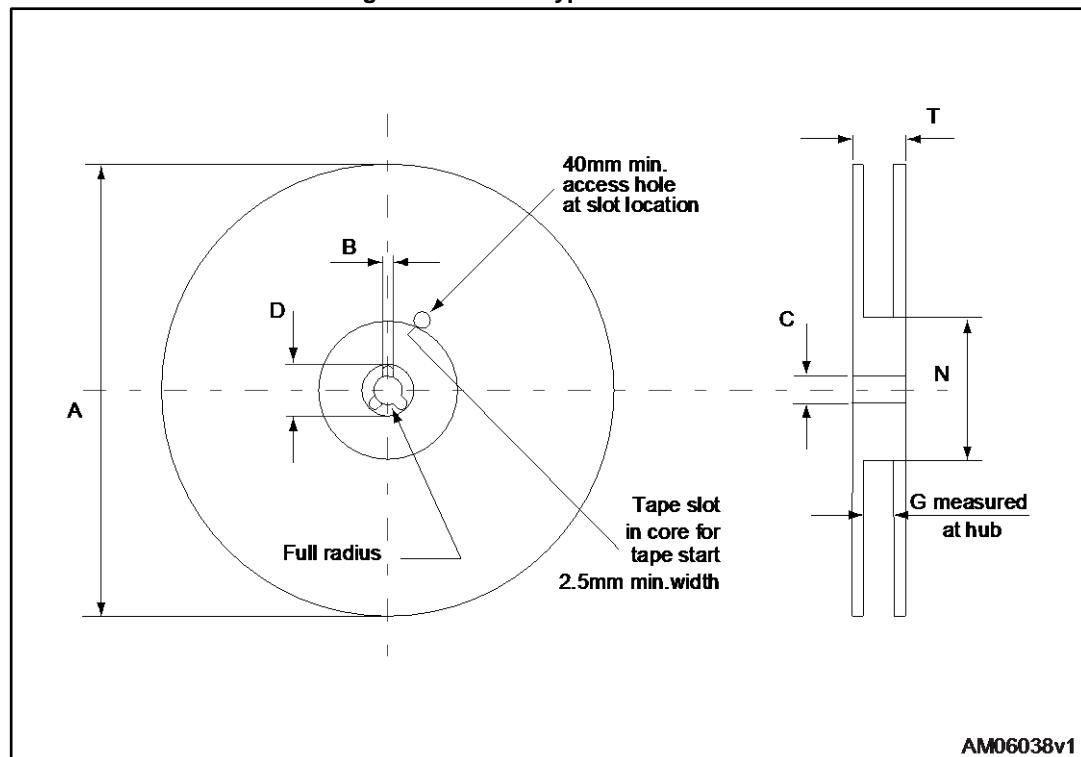
Figure 21: D<sup>2</sup>PAK type A tape outline

Figure 22: D<sup>2</sup>PAK type A reel outlineTable 10: D<sup>2</sup>PAK type A tape and reel mechanical data

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	10.5	10.7	A		330
B0	15.7	15.9	B	1.5	
D	1.5	1.6	C	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	T		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base quantity		1000
P2	1.9	2.1	Bulk quantity		1000
R	50				
T	0.25	0.35			
W	23.7	24.3			

## 5 Revision history

Table 11: Document revision history

Date	Revision	Changes
01-Feb-2012	1	First release
07-Mar-2012	2	P <sub>TOT</sub> in cover page and in <i>Table 2</i> has been updated. <i>Figure 2</i> , <i>Figure 6</i> , <i>Figure 10</i> and <i>Figure 11</i> have been updated.
02-Mar-2017	3	Updated title and features on cover page. Updated <i>Table 2: "Absolute maximum ratings"</i> , <i>Table 5: "On/off states"</i> and <i>Figure 3: "Thermal impedance"</i> . Minor text changes

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